

ICEP-IAAC 2025 Sponsorship Opportunities

2025.4/15 (Tue) ~ **4/19** (Sat)

Venue: Wakasato Municipal Cultural Hall, Nagano, Japan

ICEP-IAAC (Int'l Conf. on Electronics Packaging & iMAPS All Asia Conference) 2025 invites Conference Sponsors to participate in the conference by offering a variety of benefits, such as the use of your company's logo and advertisements, exhibiting your equipment, and attending the reception, and so on. This international conference will feature General Sessions on the fundamentals of the electric packaging field (Advanced Packaging, Design, Modeling and Reliability, Emerging technologies, High-Speed, Wireless & Components, Interconnections, Materials and Processes, Optoelectronics, Power Electronics, Thermal Management), as well as sessions on Glass Package and 3D Chiplet, which are attracting attention. We hope you will use this opportunity to promote your company and expand your human network. We look forward to receiving your registration!



ENTITLEMENT

		Diamond Sponsor ¥500,000	Platinum Sponsor ¥350,000	Gold Sponsor ¥200,000	Silver Sponsor ¥50,000
口 掲 載	Additional Logo Recognition 1 ICEP-IAAC2025 Website, Official Program & Screens during Session breaks	✓	✓	✓	✓
	Additional Logo Recognition 2 Registration Website page	✓	✓	—	—
	Additional Logo Recognition 3 On the Attendee's name badge	✓	—	—	—
告 白	Advertising Opportunities 1 Full-page (A4 size 1P) in Final Program & Proceedings	✓	✓	—	—
	Advertising Opportunities 2 Screens during Session breaks PPT1page	✓	✓	—	—
	Advertising Opportunities 3 Pre-recorded movie (1-2 min.) before a Keynote (1~2min) and in the reception or exhibition areas.	✓	—	—	—
	The booth included in sponsorship 4/16(Wed)-18(Fri)	✓	✓	✓	—
	Contact Information of Registered Attendees that Opt-In	✓	✓	✓	✓
	Complimentary Registrations (persons)	3	2	1	—
	Limitation of sponsor application (on a FCFS basis)	5	4	17	—

◎ About each benefit:

You can choose whether or not to use each benefit.

After applying, the office will contact you to confirm your application, so please select the benefits you wish to use.

Optional participant benefits are available for Diamond and Platinum Sponsor.

◎ Booth :

- Display panel 1(approx. W: 180cm, H: 210cm) & one table(approx., W:180cm D:60cm) space
- 4/16 - 18 afternoon Break Time: **Coffee break service at Exhibition area**
- 4/18 Evening at booth area: **Sponsors Exhibition Event with all attendees**
- Booth locations will be selected in the following order: **Diamond → Platinum → Gold Sponsor.**

◎ Regarding the upper limit on the number of applications:

For each sponsored class, we have set an upper limit on the number of applications as shown in the table. If you are interested, please apply as soon as possible, as it will be on a first-come, first-served basis.

SPONSOR REGISTRATION

If you would like to apply, please contact icep2025@jiep.or.jp by the end of February 2025.

INQUIRY

Please contact to Secretariat of ICEP-IAAC 2025 (JIEP)

E-mail: icep2025@jiep.or.jp URL: <http://www.jiep.or.jp/icep/>